CUC-USB3.1-J1ST-AH/UCF-SMD - USB PCB connectors



1332645

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USB PCB connectors, degree of protection: IP20, number of positions: 16, 480 Mbps, material: Metal, connection method: Solder connection, USB 2.0



Your advantages

- · Optimized for SMD reflow soldering processes
- · Can be processed automatically thanks to tape-on-reel packaging

Commercial data

Item number	1332645
Packing unit	1,000 pc
Minimum order quantity	1,000 pc
Sales key	AB14
Product key	ABNDAC
GTIN	4063151629724
Weight per piece (including packing)	0.811 g
Weight per piece (excluding packing)	22.22 g
Customs tariff number	85366930
Country of origin	CN



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Technical data

Product properties

Туре	USB-C
Product type	Data connector (device side)
Sensor type	USB 2.0
Number of positions	16
Type of packaging	Tape and Reel
[W] tape width	24.00 mm
[A] coil diameter	330.00 mm
Connection profile	USB-C
Number of slots	1
Туре	Socket
Shielded	yes
Insulation characteristics	
Overvoltage category	
Degree of pollution	2

Electrical properties

Rated voltage (III/2)	20 V
Rated surge voltage (III/2)	1500 V
Rated current	5 A
Contact resistance	40 mΩ
Frequency range	10 Hz 55 Hz
Insulation resistance	100 ΜΩ
Transmission medium	Copper
Transmission characteristics (category)	USB 2.0
Transmission speed	480 Mbps
Power transmission	100 W

Connection data

Connection technology	
Connection method	Solder connection

Dimensions

Width	8.94 mm
Height	3.26 mm
Length	7.3 mm
Orientation to	90.00 °

Material specifications

Color of the housing part	black
Flammability rating according to UL 94	V0



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Contact material	Copper alloy
Contact surface material	Gold over nickel
Contact carrier material	LCP
Housing material	Metal

Cable/line

Test voltage Core/Core	100 V
Test voltage Core/Shield	100.00 V
Acceleration	3.1 m/s ²
Halogen-free	yes

Mechanical properties

Mechanical data	
Insertion/withdrawal cycles	> 10000
Insertion force per signal contact	20.00 N
Extraction force per signal contact	< 8 N

Environmental and real-life conditions

Classification temperature $\rm T_{c}$

Solder cycles in the reflow

Test specification	
Specification	EIA 364-1000
Frequency	10-55 Hz
Sweep speed	1 octave/min
Amplitude	1.52 mm
Test duration	2.00 h
Contact resistance R ₁	40.00 mΩ
Test specification	
Specification	60068-2-27
Acceleration	50.00 g
Number of shocks per direction	18.00
Ambient conditions	
Degree of protection	IP20
Ambient temperature (operation)	-55 °C 85 °C
lounting	
Mounting type	SMD soldering
Processing notes	
Process	SMD
Moisture Sensitive Level	MSL 1

260 °C 3



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Classifications

ECLASS

ECLASS-11.0	27440390
ECLASS-12.0	27440390
ECLASS-13.0	27460201

UNSPSC

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Environmental product compliance

China RoHS	Environmentally friendly use period: unlimited = EFUP-e
	No hazardous substances above threshold values

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